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TO THE

Please record



ENTS

10/477868

1. Name of Party(ies) conveying an interest.

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by thereof.

ress of Party(ies) receiving an interest:

Yutaka Kaneda
Takeshi Chiba
Tomoki HiroyName: Kaneka Corporation
Internal Address: 2-4, Nakanoshima 3-chome
Street Address: Kita-ku, Osaka-shi
City: Osaka
State/Zip: 530-0005 Japan

Additional name(s) of conveying party(ies) attached?

☐ Yes ☒ No

Additional name(s) and addresses attached?

☐ Yes ☒ No

3. Description of the interest conveyed:

☒ Assignment☐ Change of Name

Other:

☐ Security Agreement☐ Merger

Execution Date: September 4, 2003

4. Application number(s) or patent number(s). Additional sheet attached? ☐ Yes ☒ No

If this document is being filed together with a new application, the execution date of the application is:

September 4, 2003

Date

A. Patent Application No.(s)

10477868

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

BRINKS HOFER GILSON & LIONE
P.O. BOX 10395
CHICAGO, IL 60610
(312)321-4200

6. Number of applications and patents involved: 1

7. Total fee (37 CFR 3.41)

\$ 40.00

☒ Enclosed☐ Authorized to be charged to Deposit Account No. 23-19258. ☒ Please charge any deficiencies in fee or credit any overpayment to Deposit Account No. 23-1925.

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Richard G. Lione

Name of Person Signing

Signature

Nov. 13, 2003

Date

Total number of pages including cover sheet, attachments, and document: 3

ASSIGNMENT

WHEREAS, Yutaka KANEDA, Osaka, Japan
Takeshi CHIBA, Osaka, Japan
Tomoki HIIRO, Hyogo, Japan

hereinafter called the "Assignors," have invented a new and useful invention entitled;

THERMOPLASTIC RESIN COMPOSITION

for which they have:

- (a) filed an application for United States Letters Patent on _____ as (Serial No. _____); or
- (b) executed an application for United States Letters Patent on September 4, 2003; and

WHEREAS, KANEKA CORPORATION, a corporation organized and existing under the laws of Japan, having a place of business at 2-4, Nakanoshima 3-chome, Kita-ku, Osaka-shi, Osaka 530-0005 Japan hereinafter called the "Assignee," is desirous of acquiring the entire right, title and interest in and to said invention, the application above identified, and in, to and under any Letters Patent which may be obtained to said invention, as hereinafter more fully set Forth;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of One Dollar (\$ 1.00), and other valuable and legally sufficient considerations, the receipt of which by said Assignor from the said Assignee is hereby acknowledged, the said Assignor has sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said Assignee, the entire, right, title and interest for the United States in and to the invention and application hereinabove identified, and any Letters Patent of the United States that may issue for said invention, together with the entire right, title and interest in and to said invention and applications for Letters Patent and Letters Patent therefor, in all countries foreign to the United States, including the full right to claim for any such application all benefits and priority rights under any applicable convention; to have and to hold for the sole and exclusive use and benefit of the said Assignee, its successors and assigns, to the full end of the term or terms for which any and all of said Letters Patent for said inventions may issue.

And the said Assignor does hereby covenant and agree, for himself and his legal representatives, that he will assist the said Assignee in the prosecution of the application herein identified; in the making and prosecution of any other applications for Letters Patent that the said Assignee may elect to make covering the invention herein identified, as hereinabove set forth; in vesting in the said Assignee like exclusive title in and to all such other applications and Letters Patent; and in the prosecution of any interference which may arise involving said invention, or any application or Letters Patent herein contemplated; and that he will execute and deliver to the said Assignee any and all additional papers which may be requested by the said Assignee to fully carry out the terms of this Assignment.

And the Commissioner of Patents and Trademarks is hereby authorized and requested to issue Letters Patent to the said Assignee in accordance with the terms of this Assignment.

IN TESTIMONY WHEREOF, the said Assignor has here unto set his hand.

Date: September 4, 2003 Yutaka Kaneda
Yutaka KANEDA

Date: September 4, 2003 Takeshi Chiba
Takeshi CHIBA

Date: September 4, 2003 Tomoki Hiiro
Tomoki HIIRO

Date: _____

Date: _____

Date: _____

Date: _____